INFORMATION

PRODUCT No. : **Q33310F70038600**

MODEL : **SG-310SCF**

INFO. No. : **A14-491-3A**

DATE : **Jul. 23. 2014**

SEIKO EPSON CORPORATION

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INTRODUCTION

1. The contents is subject to change without notice.
   Please exchange the specification sheets regarding
   the product's warranty.

2. This sheet is not intended to guarantee or provide
   an approval of implementation of industrial patents.

3. We have prepared this sheet as carefully as possible.
   If you find it incomplete or unsatisfactory in any
   respect, We would welcome your comments.

This product is compliant with RoHS Directive.

This Product supplied (and any technical information furnished, if any) by Seiko Epson Corporation shall not be used for the development and manufacture of weapon of mass destruction or for other military purposes. Making available such products and technology to any third party who may use such products or technologies for the said purposes are also prohibited.

This product listed here is designed as components or parts for electronics equipment in general consumer use. We do not expect that any of these products would be incorporated or otherwise used as a component or part for the equipment, which requires an extra high reliability, such as satellite, rocket and other space systems, and medical equipment, the functional purpose of which is to keep life.

Product No. / Model

The product No. of this crystal oscillator unit is Q33310F70038600.
The model is SG-310SCF.

Contents

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[1] Absolute maximum ratings

Parameter	Symbol	Value	Unit	Note
Supply voltage	V_{CC}-GND	-0.3 to +4.2	V	
Storage temperature *	T_stg	-40 to +125	°C	Stored as bare product after unpacking.
Input voltage	V_{IN}	-0.3 to V_{CC}+0.3	V	$\overline{ST}$ Terminal

* Concerning the frequency change, please refer [8] Environmental and mechanical characteristics.

[2] Operating range

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Supply voltage	V_{CC}	2.7	3.3	3.6	V	
Supply voltage	GND	0.0	0.0	0.0	V	
Input voltage	V_{IN}	GND	-	V_{CC}	V	
Operating temperature	T_use	-40	+25	+85	°C	
Output load condition	L_CMOS	-	-	15	pF	

- Start up time(0 %V_{CC}→90 %V_{CC}) of power source should be more than 150 μs.
- By-pass capacitor (0.01 μF to 0.1 μF) is connected near Vcc between Vcc and GND.
  (Refer to [12] Recommendable patterning)

[3] Frequency characteristics

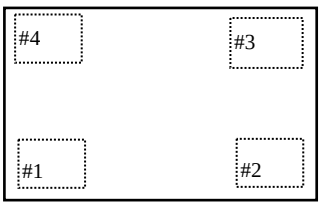
Output frequency (F_0) ..... 4 MHz

Parameter	Symbol	Value[1×10^{-6}]	Note
Frequency tolerance *	F_tol (OSC)	L : ± 50	T_use=-40 °C to +85 °C
Aging	F_aging	± 5	T_use=+25 °C, V_{CC}=3.3 V First year

* This includes initial frequency tolerance, temperature characteristics, input voltage characteristics, and load characteristics, but excludes aging.

[4] Terminal assignment

Top View



Terminal name	Terminal No.	Terminal type.
$\overline{ST}$	1	INPUT
GND	2	—
OUT	3	OUTPUT
V_{CC}	4	—

$\overline{ST}$ pin : High or open. → Specified frequency output = enable.

$\overline{ST}$ pin : Low. → Output is high impedance = disabled.

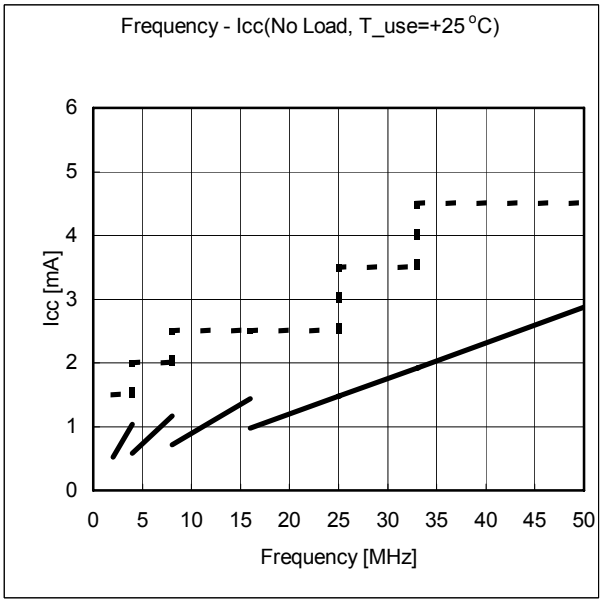
[5] Electrical characteristics

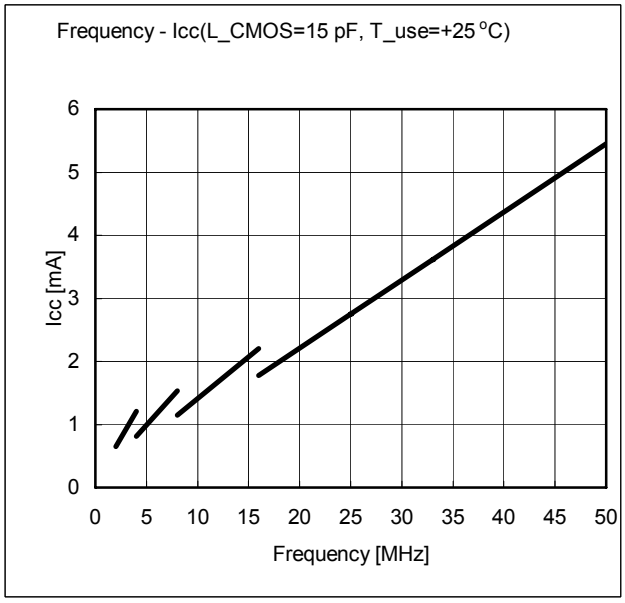
(Please see page 2 [2] Operating range)

Parameter	Symbol	Value		Unit	Note
		Min.	Max.		
Start up time	tOSC	-	10	ms	t=0 at 90 %VCC
Current consumption	ICC	-	1.5	mA	No load
Standby current	I_std	-	2.0	μA	$\overline{ST}$ =GND
Output rise time	tr	-	4.0	ns	20 %VCC → 80 %VCC
Output fall time	tf	-	4.0	ns	80 %VCC → 20 %VCC
Symmetry	SYM	45	55	%	50 %VCC Level
High level output voltage	VOH	0.9 VCC	-	V	IOH = -3 mA
Low level output voltage	VOL	-	0.1 VCC	V	IOL = 3 mA
High level input voltage	VIH	0.8 VCC	-	V	$\overline{ST}$ terminal
Low level input voltage	VIL	-	0.2 VCC	V	$\overline{ST}$ terminal
Input current	IIH	-	1.0	μA	VIN = VCC
	IIL	-1.0	-	μA	VIN = GND
Output disable time	tstp	-	100	ns	$\overline{ST}$ terminal High → Low
Output enable time	tsta	-	10	ms	$\overline{ST}$ terminal Low → High
Input pull-up resistance	RUP	4	35	MΩ	VIN=GND
		25	55	kΩ	VIN =0.8 Vcc

Refer to [6] Test circuit [7] Timing chart

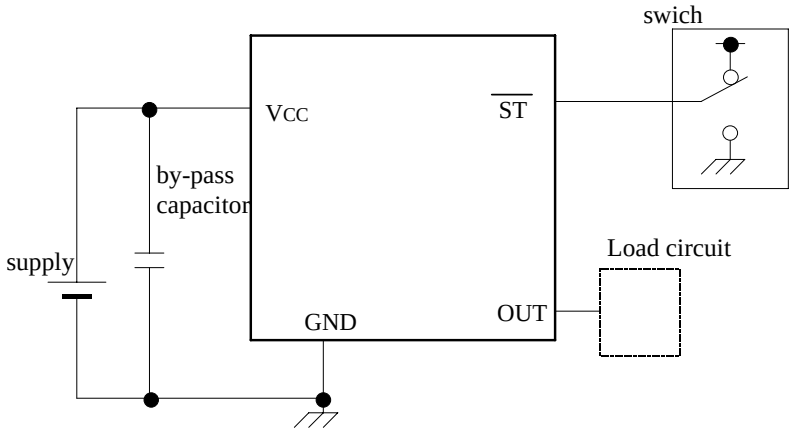
◆Reference : Current consumption Typ. Value (VCC = 3.3 V , T_use = +25℃)



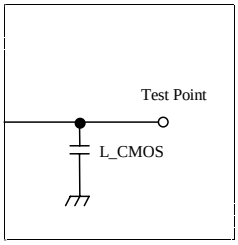


[6] Test circuit

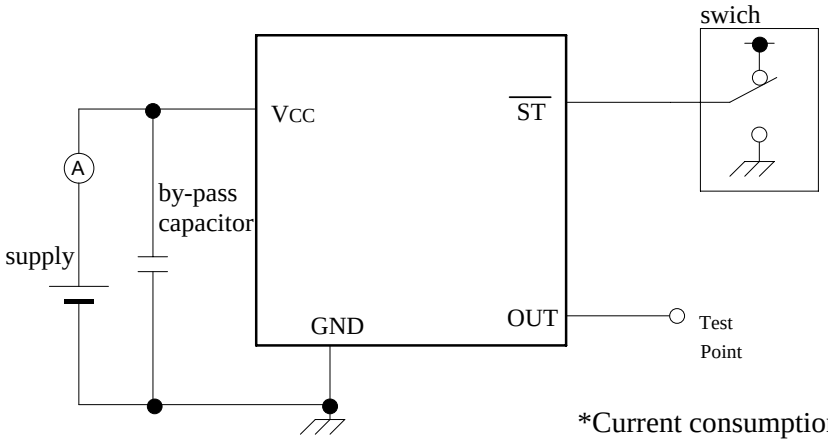
1) Waveform observation



Load circuit load capacitance



2) Current consumption



*Current consumption under the disable function should be $\overline{ST}$ = GND.

3) Condition

(1) Oscilloscope

- Band width should be minimum 5 times higher (wider) than measurement frequency.
- Probe earth should be placed closely from test point and lead length should be as short as possible.

* Recommendable to use miniature socket. (Don't use earth lead.)

(2) L_CMOS also includes probe capacitance.

(3) By-pass capacitor (0.01 μF to 0.1 μF) is placed closely between V_{CC} and GND.

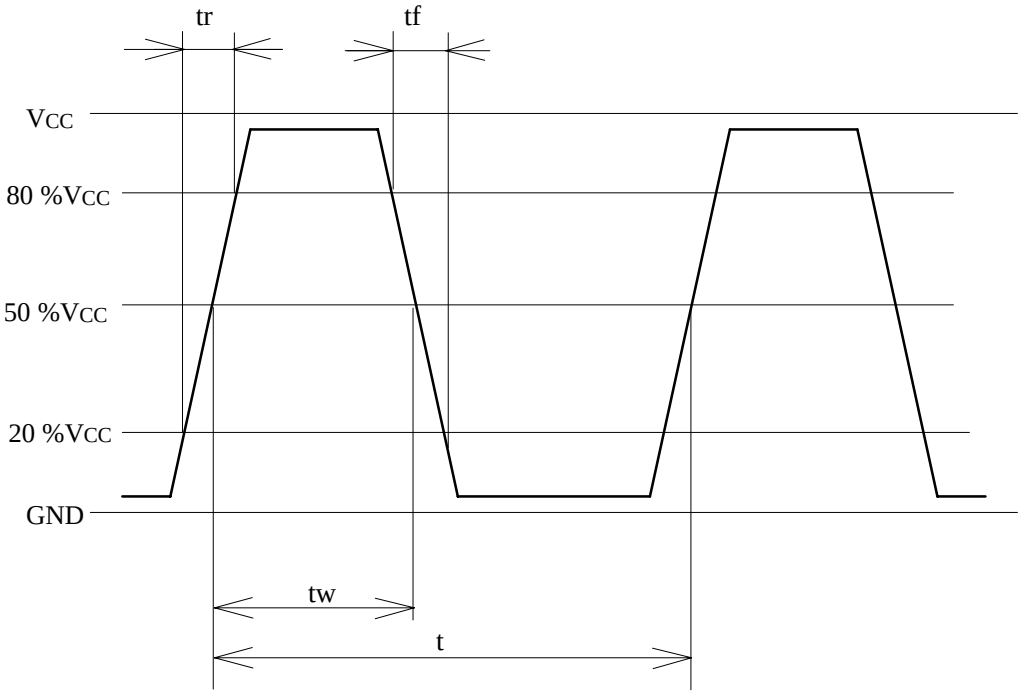
(4) Use the current meter whose internal impedance value is small.

(5) Power supply

- Start up time (0 %V_{CC} → 90 %V_{CC}) of power source should be more than 150 μs.
- Impedance of power supply should be as lowest as possible.

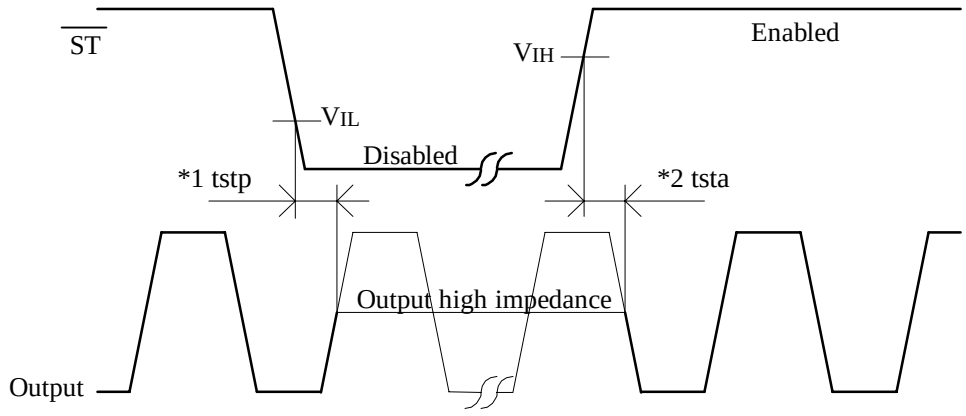
[7] Timing chart

1) C-MOS load SYM = tw/t × 100 (%)



2) $\overline{ST}$ function and timing

$\overline{ST}$ function	Osc. circuit	Output status
High or Open	Oscillation	Specified frequency is output : Enable
Low	Oscillation stop	Output becomes high impedance : Disable



*1 The time taken from $\overline{ST}$ =VIL to output = Disable (high impedance)

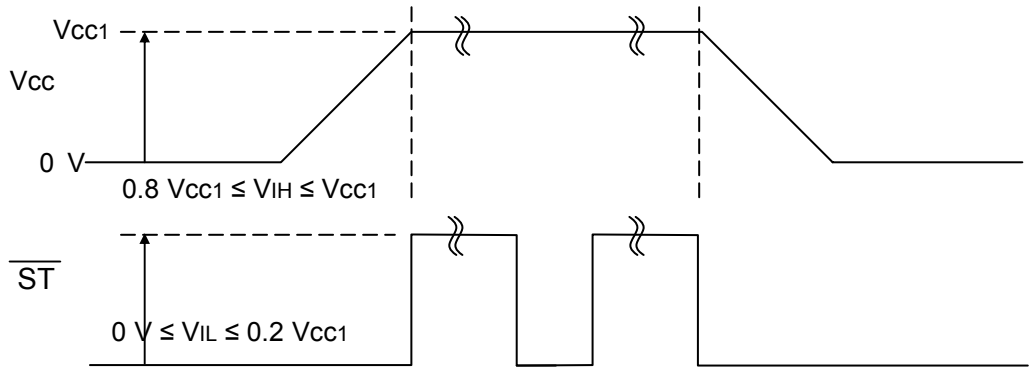
*2 The time taken from $\overline{ST}$ =VIH to output = Start

Output start : VOH≥0.8 %VCC, VOL≤0.2 %VCC, Fout = Fo±1 000×10^{-6}

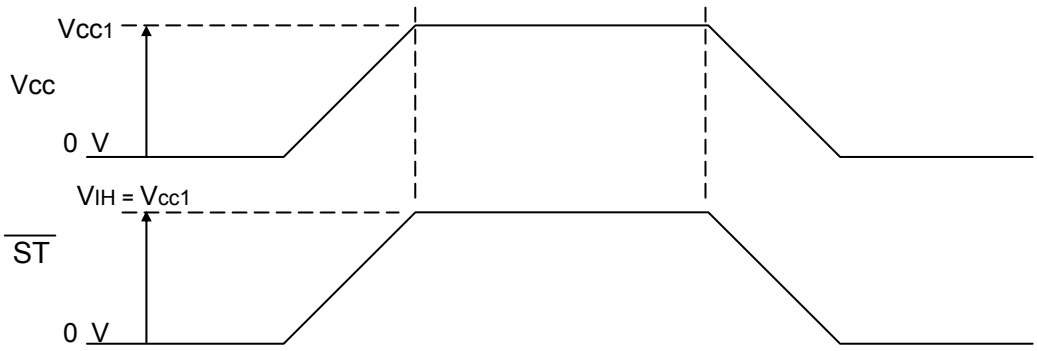
3) $\overline{ST}$ Control timing

$\overline{ST}$ function is used on the voltage below supply voltage.

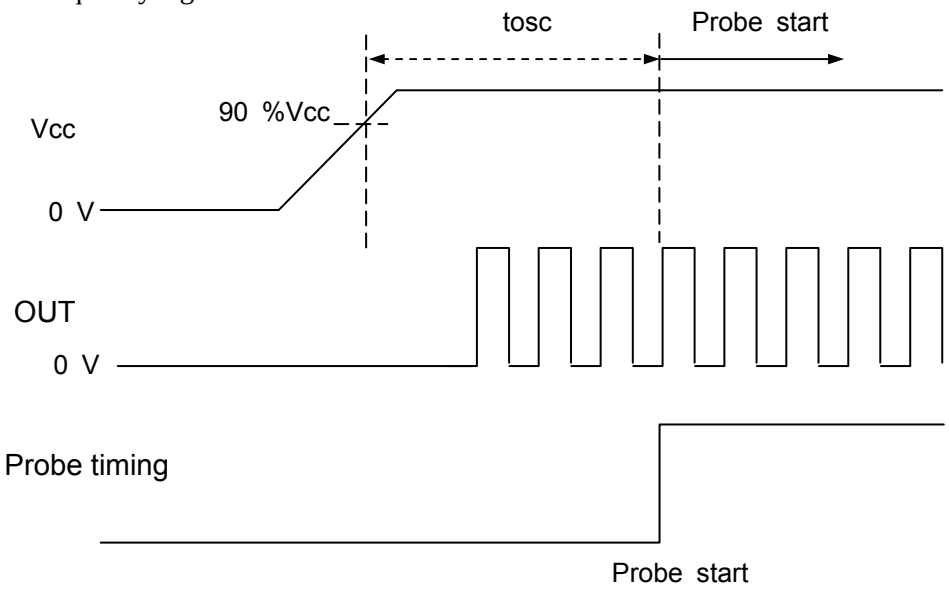
$\overline{ST}$ control timing differs from Vcc control timing



$\overline{ST}$ terminal is connected to Vcc terminal



4) Timing of an output frequency signal



[8] Environmental and mechanical characteristics

(The company evaluation condition We evaluate it by the following examination item and examination condition.)

No.	Item	Value *1		Test Conditions
		Δ f / f *2 [1×10^{-6}]	Electrical characteristics	
1	High temperature storage	*3 ± 50	Satisfy Item [5] after test.	+125 °C × 1 000 h
2	Low temperature storage	*3 ± 10		-40 °C × 1 000 h
3	High temperature bias	*3 ± 20		+85 °C × V Max. × 1 000 h
4	Low temperature bias	*3 ± 10		-40 °C × V Max. × 1 000 h
5	Temperature humidity bias	*3 ± 20		+85 °C × 85 %RH × V Max. × 1 000 h
6	Temperature cycle	*3 ± 20		-40 °C ↔ +125 °C 30 min. at each temperature 100 cycles
7	Resistance to soldering heat	± 10		Convection reflow soldering furnace (3 time) Ref. IPC/JEDEC J-STD-020D.1
8	Shock	± 5		100 g dummy Jig (SE Standard) drop from 1 500 mm height on the Concrete 3 directions 10 times.
9	Vibration	± 10		10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s^2 10 Hz → 500 Hz → 10 Hz 15 min./cycle 6 h (2 hours , 3 directions)
10	Seal	1×10^{-9} Pa·m^3 / s		He leakage detector
11	Pull - off	No peeling-off at a solder part		10 N press for 10 s ± 1 s Ref. EIAJ ED-4702
12	Solderability	Termination must be 95 % covered with fresh solder		Dip termination into solder bath at +235 °C ± 5 °C for 5 s. (Using Rosin Flux)

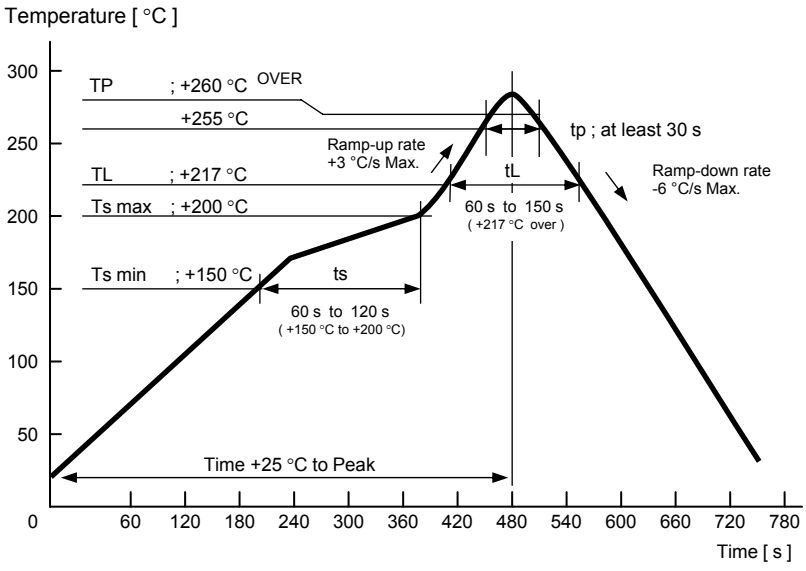
< Notes >

*1 Each test done independently.

*2 Measuring 2 h to 24 h later leaving in room temperature after each test.

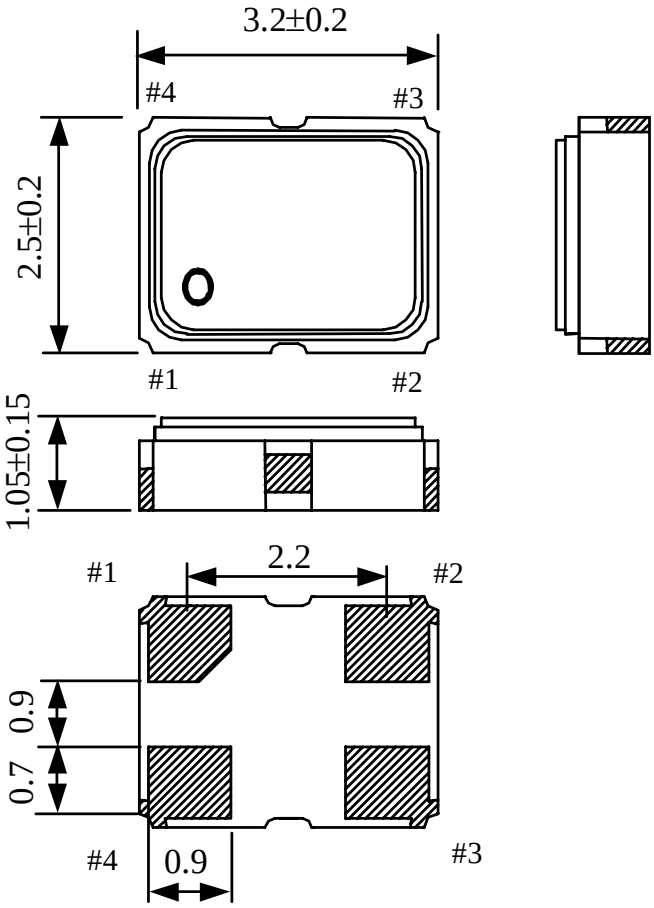
*3 Initial value shall be measured after 24 h storage at room temperature after pre-conditioning.
Pre-conditioning: Reflow (3 time)

Convection reflow condition (Ref. IPC/JEDEC J-STD-020D.1)



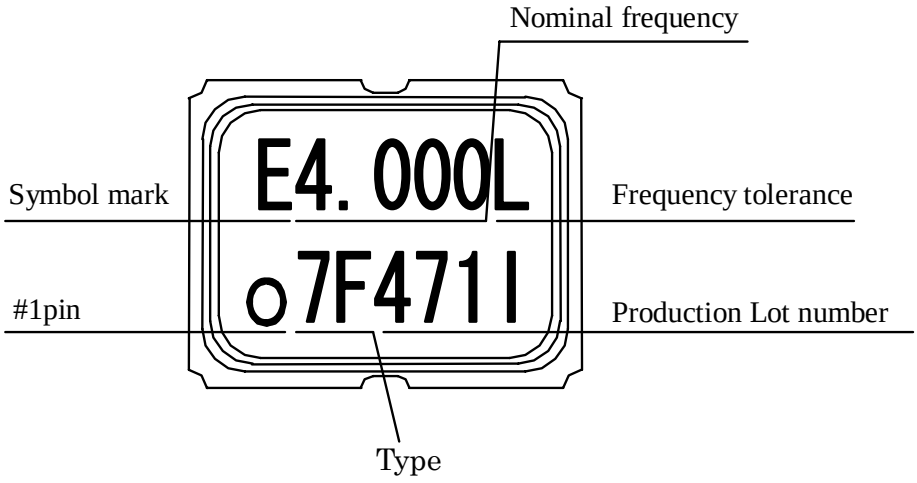
[9] Dimensions and marking layout

1) Dimensions



Terminal treatment : Au plating
Unit : mm

2) Marking layout



- ♦ The above marking layout shows only marking contents and their approximate position and it is not for font, size and exact position.
- ♦ Output frequency shall indicate 5 digits (include decimal point), if the value of frequency over 5 digits, the least significant digits will be omitted.

[10] Notes

1) This device is made with C-MOS IC.
Please take necessary precautions to prevent damage due to electrical static discharge.

2) SEIKO EPSON recommends a 0.01 μF to 0.1 μF capacitor must be connected near Vcc between Vcc and GND to obtain stable operation and protect against power line ripple.
(Refer to [12] Recommendable patterning)

3) Vcc and GND pattern shall be as large as possible so that high frequency impedance shall be small.

4) SEIKO EPSON cannot recommend to put filtering element into power line so as to reduce noise. Oscillator might be unstable oscillation because high frequency impedance of power line become higher. When use filtering element, please verify electrical construction and or element's spec.

5) SEIKO EPSON doesn't recommend to power on from intermediate electric voltage or extreme fast power on, Those powering conditions may cause no oscillation or abnormal oscillation.

6) Power ripple: 200 mV P-P max. Start up time (0 %V_{CC}→90 %V_{CC}) of power source should be more than 150 μs.

7) A long output line may cause irregular output, so try to make the output line as short as possible.

8) Other high-level signal lines may cause incorrect operation, so please do not place high level signal line close to this device.

9) This device contains a crystal resonator, so please don't expose excessive shock or vibration. SEIKO EPSON recommends store device under normal temperature and humidity to keep the specification.

10) An automatic insertion is available, however, the internal crystal resonator might be damaged in case that too much shock or vibration is applied by machine condition.
Be sure to check your machine condition in advance.

11) Ultrasonic cleaning can be used on the SG-310SCF, however, since the oscillator might be damaged under some conditions, please exercise in advance.

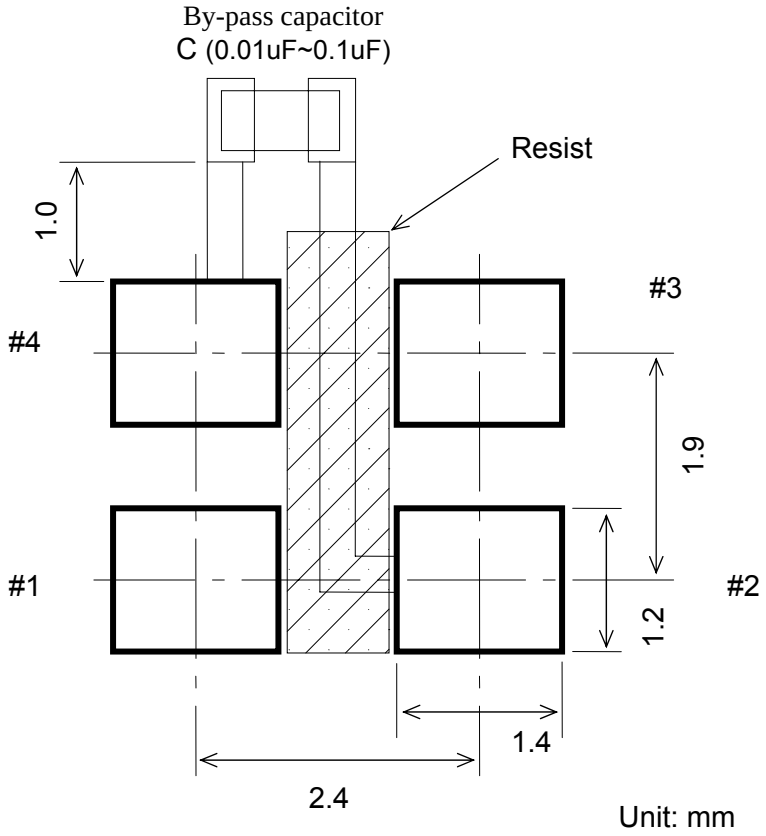
12) SEIKO EPSON recommends to use and store under room temperature and normal humidity to secure frequency accuracy and prevent moisture.

13) $\overline{ST}$ -pin has pull-up resistor internally. The resistor value is switched depending on input voltage.
Please refer to electrical characteristics.

[11] Recommendable patterning

The soldering pad sample indicated as like following:

Soldering position (Unit : mm)



TAPING SPECIFICATION

Ⅰ. Application

This standard will apply to 3.2×2.5 Ceramic package.

Spec：CE package

Ⅱ. Contents

Item No.	Item	Page
[1]	Taping specification	1 to 2
[2]	Inner carton	3
[3]	Shipping carton	
[4]	Marking	4
[5]	Quantity	
[6]	Storage environment	
[7]	Handling	

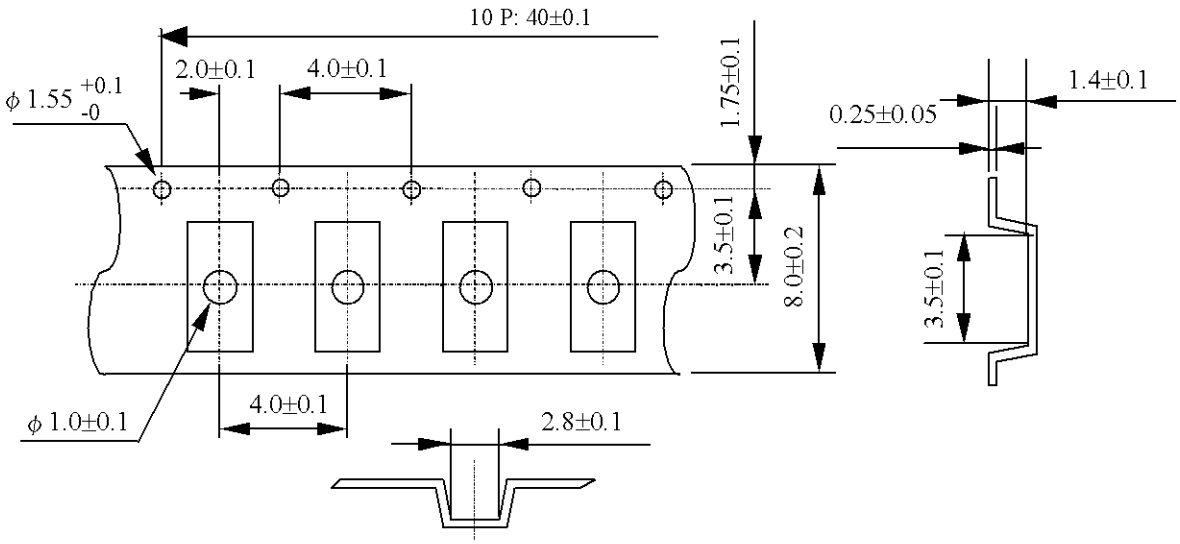
〔1〕 Taping specification

Subject to「EIA-481」and「IEC-60286」

(1) Tape dimensions

Material of the carrier tape : P S

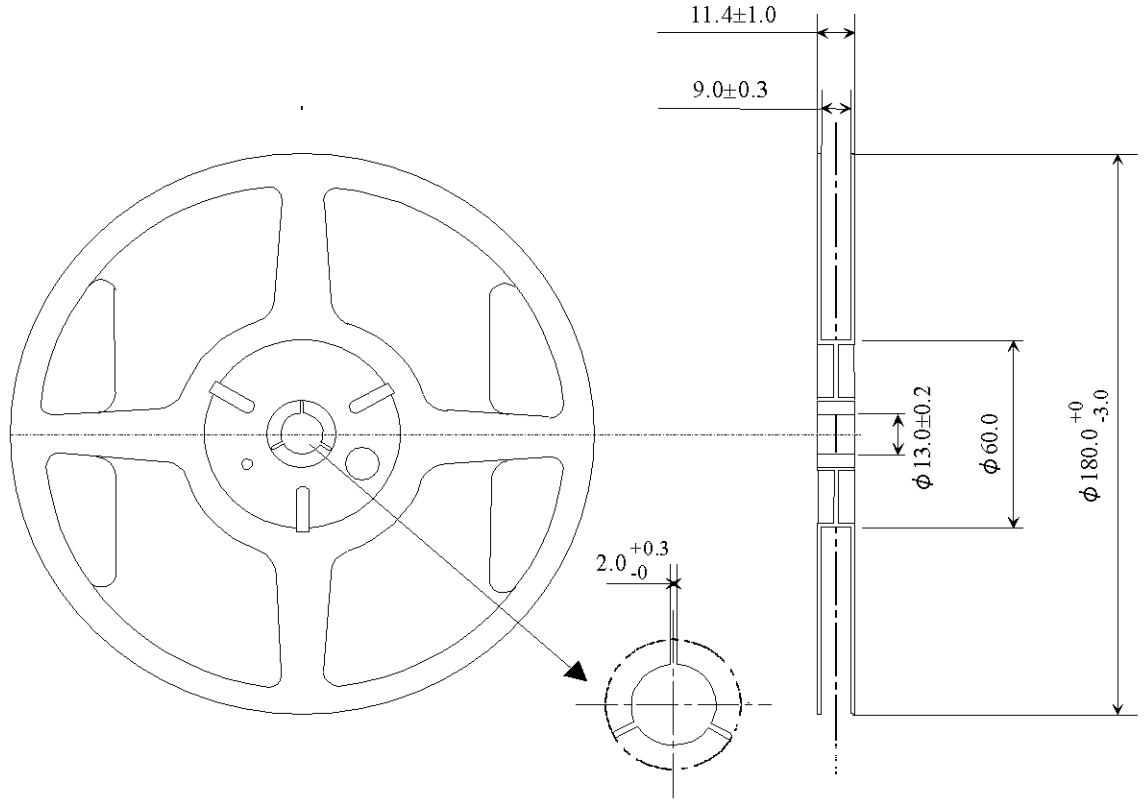
Material of the top tape : PET+PE



Unit : mm

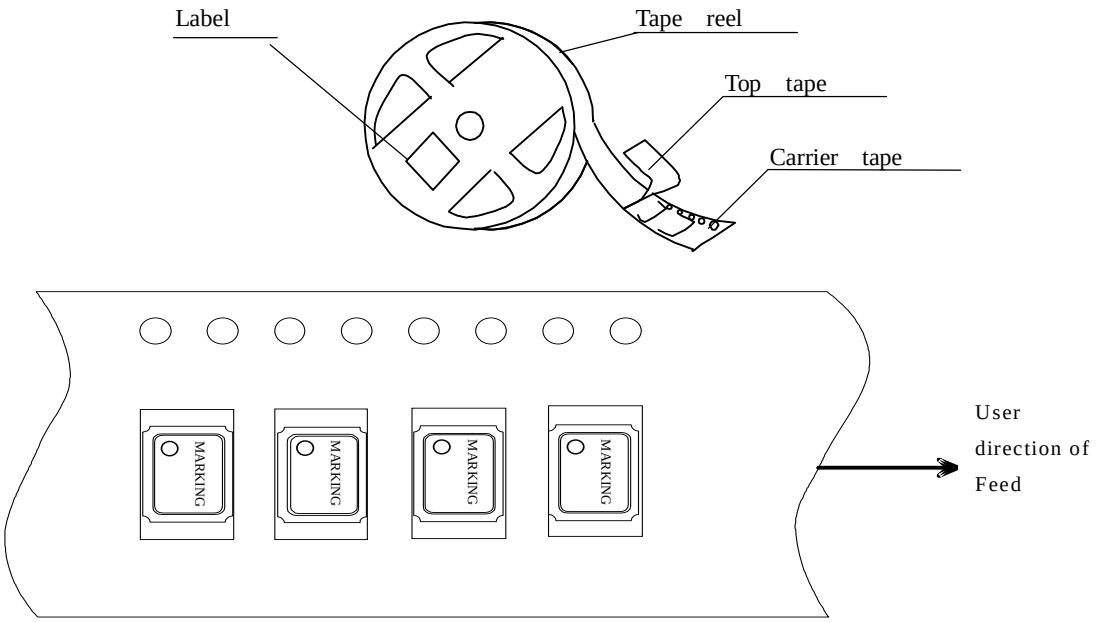
(2) Reel dimensions

Material of the reel : Conductive polystyrene

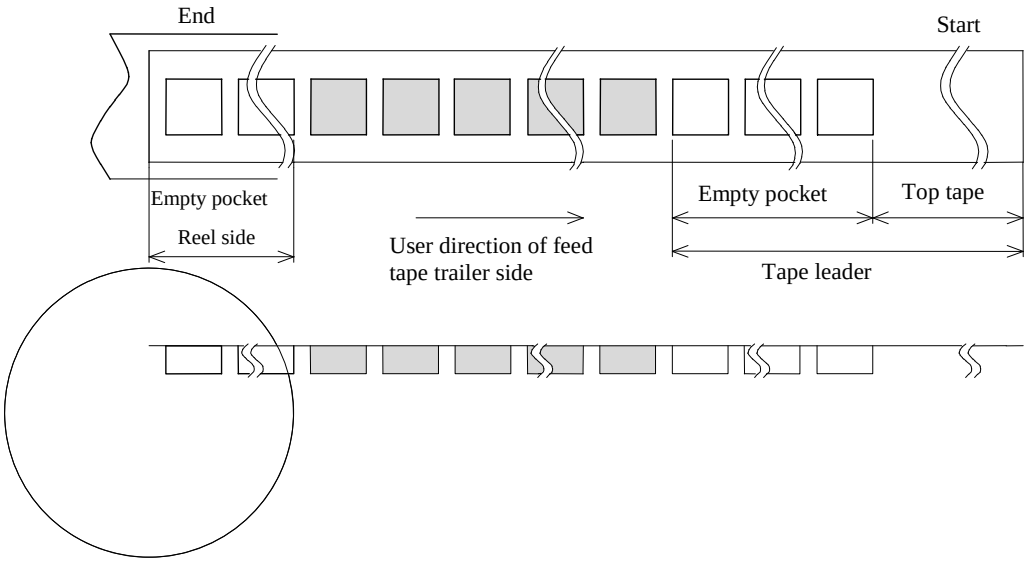


(3) Packing

①Tape & reel



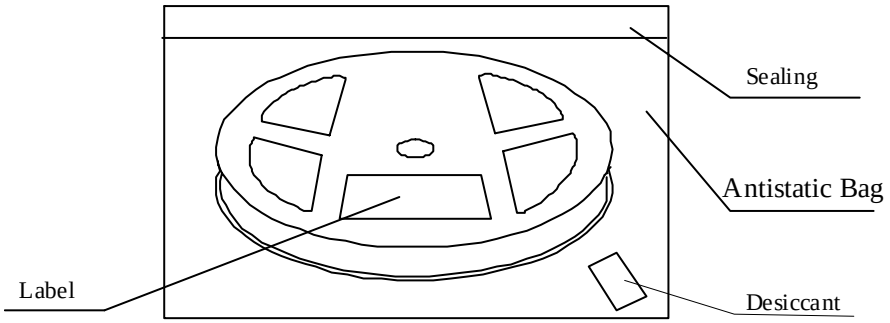
②Start & end point



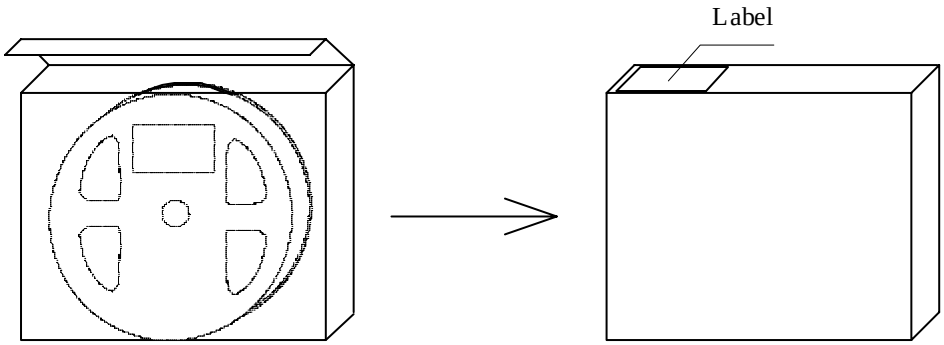
Item		Empty space
Tape leader	Top tape	Min. 1 000 mm
	Carrier tape	Min. 160 mm
Tape trailer	Top tape	Min. 0 mm
	Carrier tape	Min. 160 mm

〔2〕 Inner carton

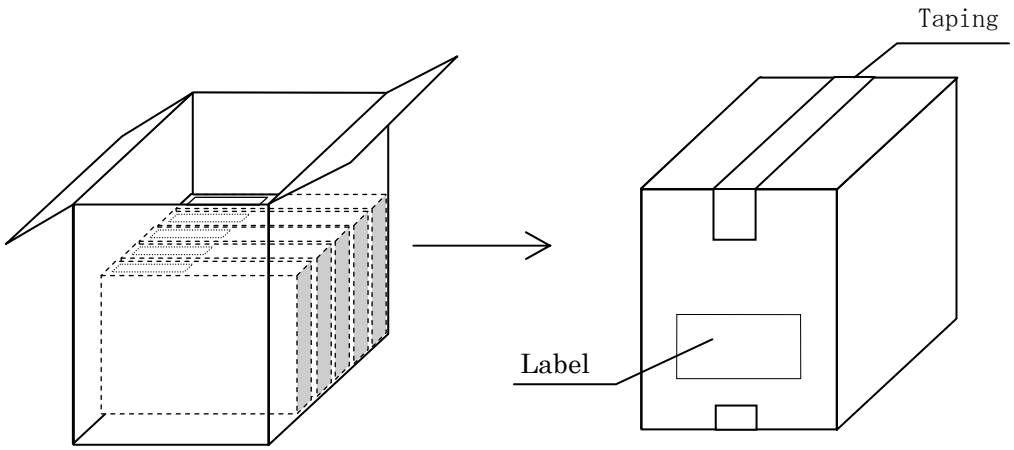
a) Packing to antistatic bag



b) Packing to inner carton



〔3〕 Shipping carton



〔4〕 Marking

(1) Reel marking

・Reel marking shall consist of :

1) Parts name
2) Quantity
3) Manufacturing date or symbol
4) Manufacturer's date or symbol
5) Others (if necessary)

(2) Inner carton marking

・Same as reel marking.

(3) Shipping carton marking

・Shipping carton marking shall consist of :

1) Parts name
2) Quantity

〔5〕 Quantity

・ 2,000 pcs./reel

〔6〕 Storage environment

(1) Before open the packing, we recommend to keep less than +30 °C and 85 %RH of Humidity, and to use it less than 6 months after delivery.

(2) We recommend to open Package in immediately before use. After open Package, We recommend to keeps less than 6 month. No need dry air before soldering work if it is less than temperature +30 °C, 85 humidity %RH.

(3) Not to expose the sun.

(4) Not to storage with some erosive chemicals.

(5) Nothing is allowed to put on the reel or carton to prevent mechanical damage.

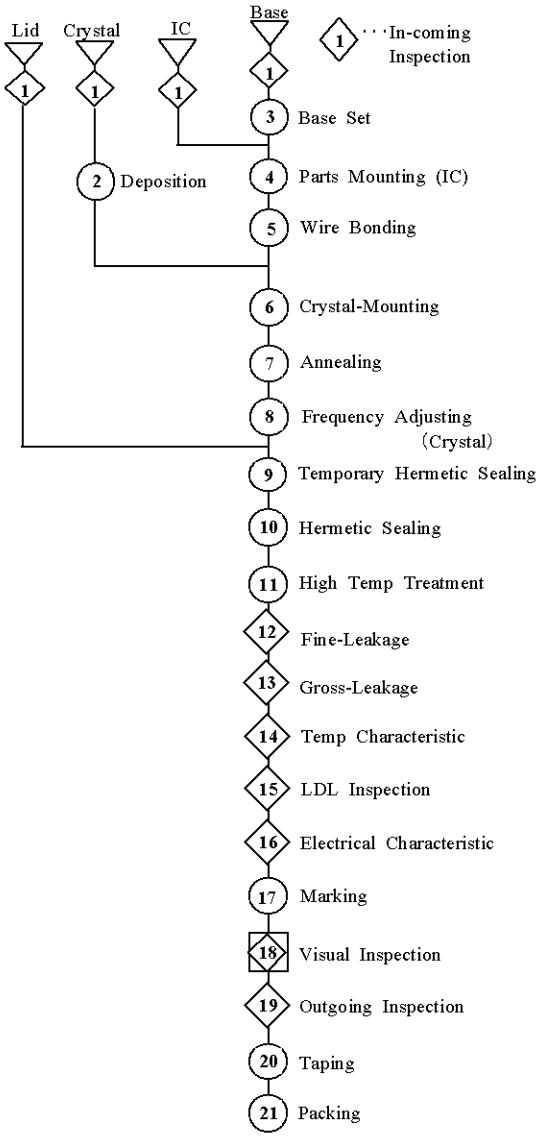
〔7〕 Handling

・To handle with care to prevent the damage of tape, reel and products.

- PROCESS QUALITY CONTROL -

No. SG310S*F - 00 - AEE - 5　　CRYSTAL OSCILLATOR : SG-310S*F

'12.7.2

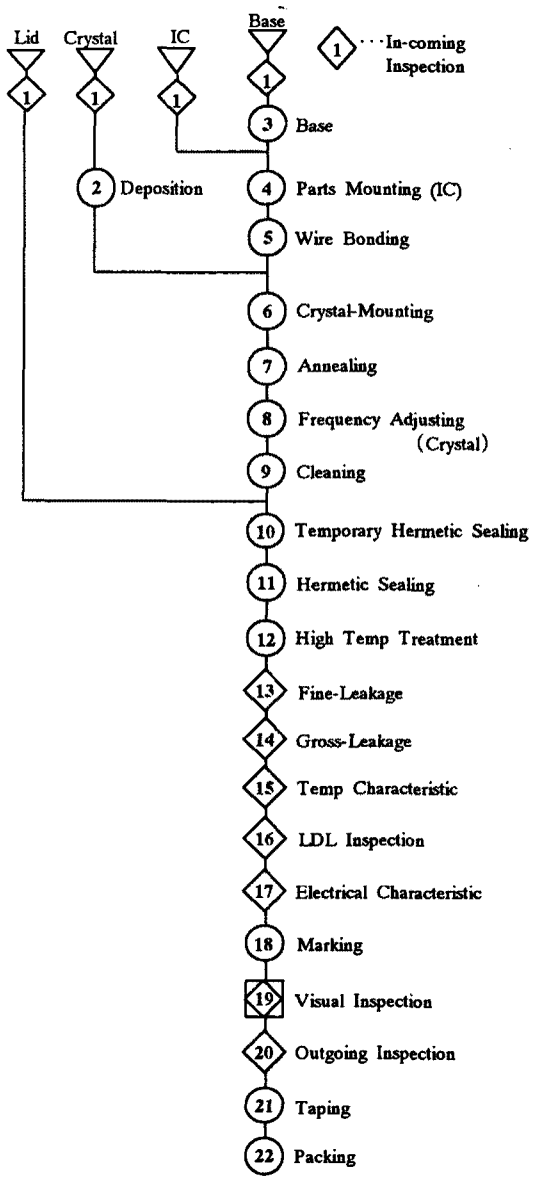
Manufacturing process chart	No.	Section In Charge	Standards	Inspection, Control Item	Instruments	Inspection Methods	Record
	1	Inspection Section	Purchasing Specification Incoming Inspection Standard	Appearance Dimension	Microscope	Sampling	Data sheet
	2	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Peeling Strength Frequency	Microscope Scratch CI Meter	Sampling	Data sheet
	3	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
	4	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
	5	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Bonding strength Appearance	Gauge Microscope	Sampling 100% Inspection	Data sheet
	6	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	100% Inspection	Data sheet
	7	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
	8	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	—	—	—	—
	9	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
	10	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Frequency	Microscope Counter	Sampling Sampling	Data sheet
	11	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	—	—	—	—
	12	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Leakage Inspection	Measuring equipment	100% Inspection	Data sheet
	13	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Leakage Inspection	Measuring equipment	100% Inspection	Data sheet
	14	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Temp Characteristic Inspection	Measuring equipment	Sampling	Data sheet
	15	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Characteristic Inspection	Measuring equipment	100% Inspection	Data sheet
	16	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Electrical Characteristic	Measuring equipment	100% Inspection	Data sheet
	17	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Visual Inspection	Sampling	Data sheet
	18	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
	19	Malaysia Plant (Inspection Section)	Delivery Specifications Outgoing Inspection Standard	Electrical Characteristic Appearance	Measuring equipment Visual Inspection	Sampling	Data sheet
	20	Malaysia Plant (Production Section)	Manufacturing Instruction Sheet	Tape peeling Strength	Peeling strength test machine	Sampling	Data sheet
	21	Malaysia Plant (Production Control Section)	Manufacturing Instruction Sheet Daily Shipping List	Customers Type Quantity	—	—	Delivery Slip

- PROCESS QUALITY CONTROL -

No. SG310S*F - 00 - ASE - 2 CRYSTAL OSCILLATOR : SG-310S*F

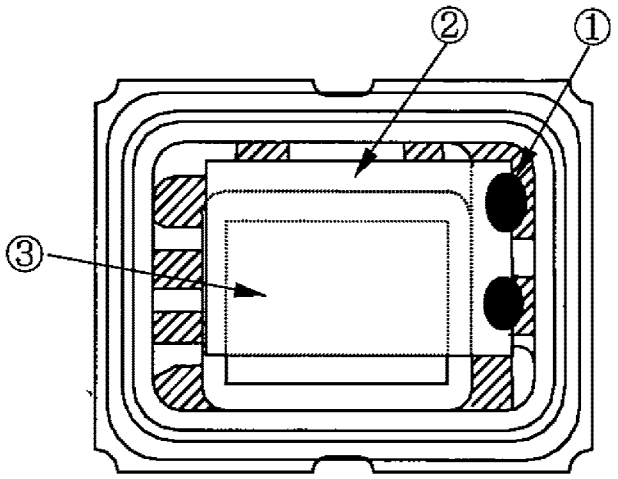
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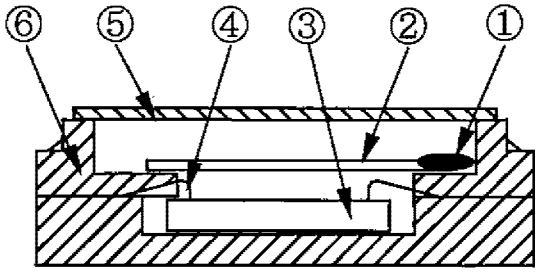
Manufacturing process chart

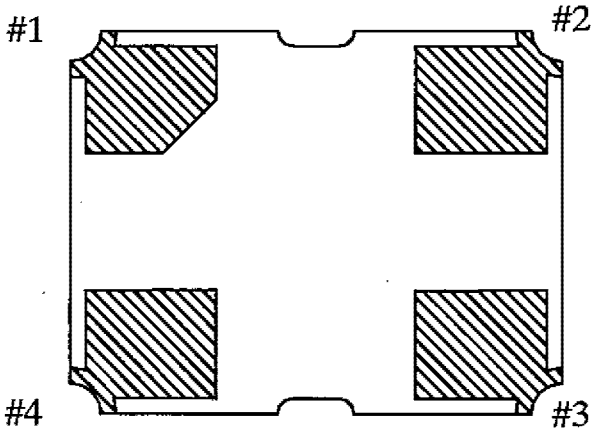


No.	Section In Charge	Standards	Inspection, Control Item	Instruments	Inspection Methods	Record
1	Inspection Section	Purchasing Specification Incoming Inspection Standard	Appearance Dimension	Microscope	Sampling	Data sheet
2	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Peeling Strength Frequency	Microscope Scratch CI Meter	Sampling	Data sheet
3	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
4	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
5	China Plant (Production Section)	Manufacturing Instruction Sheet	Bonding strength Appearance	Gauge Microscope	Sampling 100% Inspection	Data sheet
6	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	100% Inspection	Data sheet
7	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
8	China Plant (Production Section)	Manufacturing Instruction Sheet	—	—	—	—
9	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Visual Inspection	100% Inspection	Data sheet
10	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
11	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Frequency	Microscope Counter	Sampling Sampling	Data sheet
12	China Plant (Production Section)	Manufacturing Instruction Sheet	—	—	—	—
13	China Plant (Production Section)	Manufacturing Instruction Sheet	Leakage Inspection	Measuring equipment	100% Inspection	Data sheet
14	China Plant (Production Section)	Manufacturing Instruction Sheet	Leakage Inspection	Measuring equipment	100% Inspection	Data sheet
15	China Plant (Production Section)	Manufacturing Instruction Sheet	Temp Characteristic Inspection	Measuring equipment	Sampling	Data sheet
16	China Plant (Production Section)	Manufacturing Instruction Sheet	Characteristic Inspection	Measuring equipment	100% Inspection	Data sheet
17	China Plant (Production Section)	Manufacturing Instruction Sheet	Electrical Characteristic	Measuring equipment	100% Inspection	Data sheet
18	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Visual Inspection	Sampling	Data sheet
19	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
20	China Plant (Inspection Section)	Delivery Specifications Outgoing Inspection Standard	Electrical Characteristic Appearance	Measuring equipment Visual Inspection	Sampling	Data sheet
21	Chaina Plant (Production Section)	Manufacturing Instruction Sheet	Tape peeling Strength	Peeling strength test machine	Sampling	Data sheet
22	Chaina Plant (Production Control Section)	Manufacturing Instruction Sheet Daily Shipping List	Customers Type Quantity	—	—	Delivery Slip

Structure diagram SG-310S*F







LIST		
Name of part		Material
①	Crystal adhesive	Ag paste
②	Crystal chip	AT cut
③	IC	C-MOS
	IC conductive adhesive	Ag paste
④	Bonding wire	Au
⑤	Cap	Cover
⑥	Package	Ceramic (Al_2O_2)

RELIABILITY TEST DATA

Product Name : SG-310 Series

The Company evaluation condition

We evaluate environmental and mechanical characteristics by the following test condition . **No. IC-G-0521-01-001E**

No.	ITEM	TEST CONDITIONS	VALUE *1		TEST Qty [n]	FAIL Qty [n]
			$\Delta f / f$ *2 [1×10^{-6}]	Electrical characteristics		
1	High temperature storage	+125 ℃ × 1 000 h	*3 ± 50	Satisfy specification after test	22	0
2	Low temperature storage	-40 ℃ × 1 000 h	*3 ± 10		22	0
3	High temperature bias	+85 ℃ × spec. bias × 1 000 h	*3 ± 20		22	0
4	Low temperature bias	-40 ℃ × spec. bias ×1 000 h	*3 ± 10		22	0
5	Temperature humidity bias	+85 ℃ × 85 %RH × spec. bias × 1 000 h	*3 ± 20		22	0
6	Temperature cycle	-40 ℃ ⇔ +125 ℃ 30 min. at each temperature 100 cycles	*3 ± 20		22	0
7	Resistance to soldering heat	Infrared - reflow or convention reflow soldering furnace (3 times)	± 10		22	0
8	Shock	100g dummy Jig(Epson Toyocom Standard) drop from 1500mm height on the Concrete 3 directions 10 times	± 5		22	0
9	Vibration	10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s^2 10 Hz → 500 Hz → 10 Hz 15 min./cycle 6 h (2 hours , 3 directions)	± 10		22	0
10	Seal	He leakage detector	1×10^{-9} Pa·m^3/s		11	0
11	Pull - off	10 N press for 10 s ± 1 s Ref.EIAJ ED-4702	No peeling-off at a solder part		11	0
12	Solderability	Dip termination into solder bath at +235 ℃ ± 5 ℃ for 5s . (Using Rosin Flux)	Termination must be 95 % covered with fresh solder		11	0

Notes

1. *1 Each test done independently.
2. *2 Measuring 2 h to 24 h later leaving in room temperature after each test.
3. *3 Pre conditionings Initial value shall be after 24 h at room temperature after pre-conditioning.

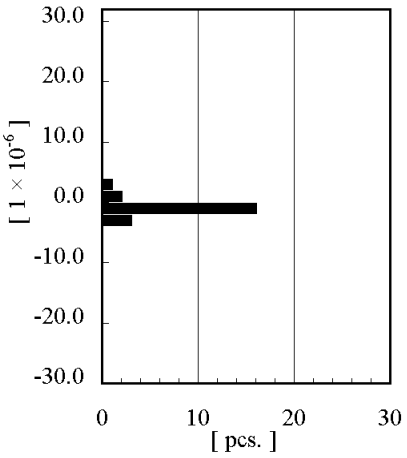
Qualification Data

Product Name : SG-310 Series

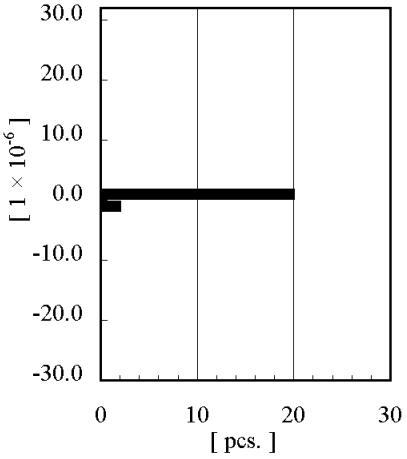
Δf / f

No. IC-G-0521-01-001E

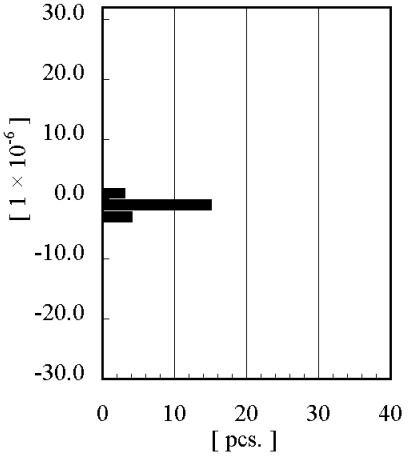
1. High temp. storage
+125 ℃× 1 000 h



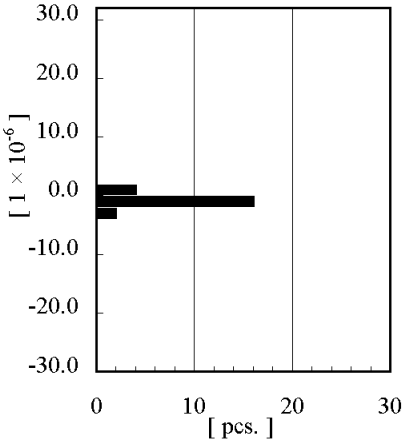
2. Low temp. storage
-40 ℃× 1 000 h



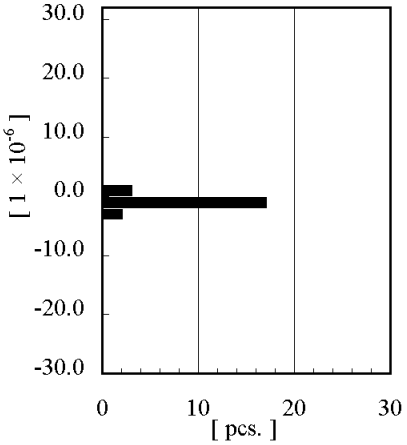
3. High temp. bias
+85 ℃× spec. bias × 1 000 h



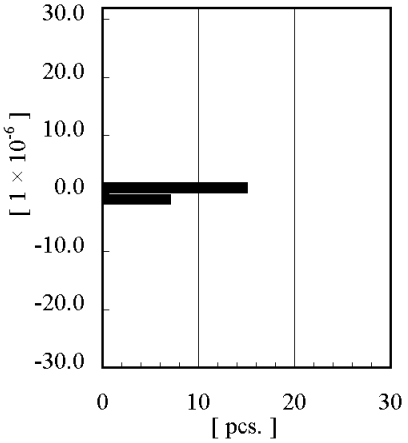
4. Low temp. bias
-40 ℃× spec. bias × 1 000 h



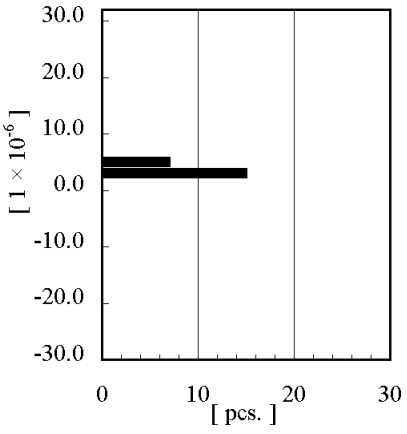
5. Temp. humidity bias
+85 ℃× 85 %RH × spec. bias
× 1 000 h



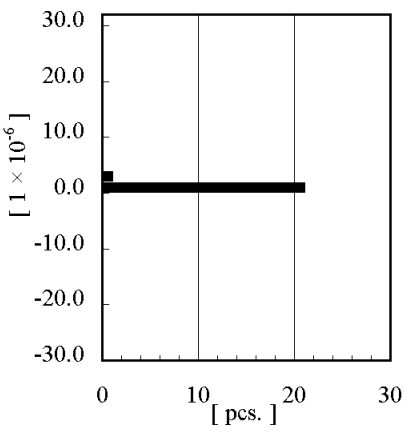
6. Temp. cycle
-40 ℃ ⇔ +125 ℃
100 cycles



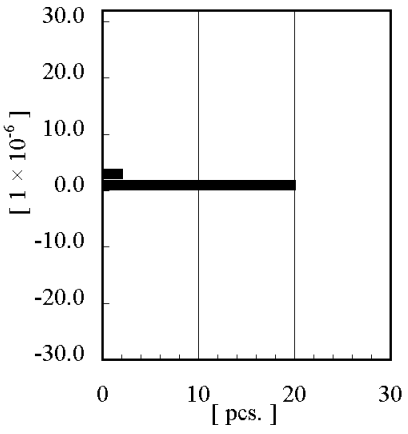
7.Resistance to soldering heat
Infrared - reflow or covention
reflow soldering furnace (3 times)



8. Shock
1 500 mm × 10 times× 100g



9. Vibration
10 Hz to 55 Hz amplitude 0.75 mm
55 Hz to 500 Hz acceleration 98 m/s^2
15 min / cycle 6 h (2 h ×3 directions)



Qualification Data